

N-Channel Enhancement-Mode Vertical DMOS FET

Features

- Low threshold (1.6V max.)
- High input impedance
- Low input capacitance
- Fast switching speeds
- Low on-resistance
- ▶ Free from secondary breakdown
- Low input and output leakage

Applications

- Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches

General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Part Number	Package Option	Packing
TN0104N3-G	TO-92	1000/Bag
TN0104N3-G P002		
TN0104N3-G P003		
TN0104N3-G P005	TO-92	2000/Reel
TN0104N3-G P013		
TN0104N3-G P014		
TN0104N8-G	TO-243AA (SOT-89)	2000/Reel

⁻G denotes a lead (Pb)-free / RoHS compliant package. Contact factory for Wafer / Die availablity.

Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV _{DSS}
Drain-to-gate voltage	BV _{DGS}
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

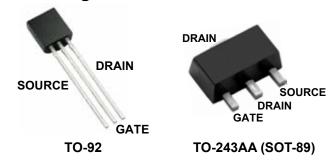
Typical Thermal Resistance

Package	θ_{ja}
TO-92	132°C/W
TO-243AA (SOT-89)	133°C/W

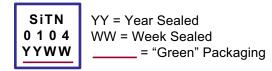
Product Summary

$BV_{DSX}\!/BV_{DGX}$	R _{DS(ON)} (max)	I _{DSS} (min)
40V	1.8Ω	2.0A

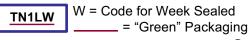
Pin Configuration



Product Marking



Package may or may not include the following marks: Si or **10-92**



Package may or may not include the following marks: Si or



Thermal Characteristics

Package	Ι _D (continuous) [†]	l _D (pulsed)	Power Dissipation @T _c = 25°C	l _{DR} †	I _{DRM}
TO-92	450mA	2.40A	1.0W	450mA	2.40A
TO-243AA (SOT-89)	630mA	2.90A	1.6W [‡]	630mA	2.90A

Notes:

- † I_D (continuous) is limited by max rated T_j . ‡ T_A = 25°C. Mounted on FR5 Board, 25mm x 25mm x 1.57mm. Significant P_D increase possible on ceramic substrate.

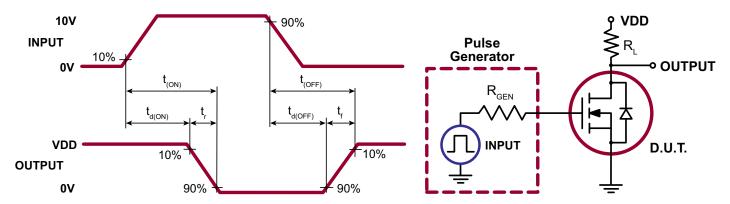
Electrical Characteristics (T_A = 25°C unless otherwise specified)

Sym	Parameter		Min	Тур	Max	Units	Conditions		
BV _{DSS}	Drain-to-source breakdown	40	-	-	V	$V_{GS} = 0V, I_D = 1.0 \text{mA}$			
V _{GS(th)}	Gate threshold voltage	0.6	-	1.6	V	$V_{GS} = V_{DS}, I_{D} = 500 \mu A$			
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with tempe	-	-3.8	-5.0	mV/ºC	$V_{GS} = V_{DS}, I_{D} = 1.0 \text{mA}$			
I _{GSS}	Gate body leakage		-	0.1	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
		-	-	1.0		$V_{GS} = 0V, V_{DS} = Max Rating$			
l _{DSS}	Zero gate voltage drain curi	-	-	100	μA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$, $T_{A} = 125$ °C			
		-	0.35	-		$V_{GS} = 3.0V, V_{DS} = 20V$			
I _{D(ON)}	On-state drain current			1.1	-	Α	$V_{GS} = 5.0V, V_{DS} = 20V$		
		2.0	2.6	-		$V_{GS} = 10V, V_{DS} = 20V$			
		Both packages	-	5.0	-		$V_{GS} = 3.0V, I_{D} = 50mA$		
D	Static drain-to-source on-state resistance	Bolli packages	-	2.3	2.5	Ω	$V_{GS} = 5.0V, I_{D} = 250mA$		
R _{DS(ON)}		TO-92	-	1.5	1.8		V - 10V L - 10A		
		TO-243AA	-	-	2.0		$V_{GS} = 10V, I_{D} = 1.0A$		
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with temp	erature	-	0.7	1.0	%/°C	V _{GS} = 10V, I _D = 1.0A		
G_{FS}	Forward transductance		340	450	-	mmho	$V_{DS} = 20V, I_{D} = 500mA$		
C _{ISS}	Input capacitance		-	-	70		V _{GS} = 0V,		
C _{oss}	Common source output cap	acitance	-	-	50	pF	V _{DS} = 20V, f = 1.0MHz		
C _{RSS}	Reverse transfer capacitant	ce	-	-	15		f = 1.0MHz		
t _{d(ON)}	Turn-on delay time		-	3.0	5.0				
t _r	Rise time		-	7.0	8.0	ns	$V_{DD} = 20V,$ $I_{D} = 1.0A,$		
t _{d(OFF)}	Turn-off delay time			6.0	9.0	115	$R_{GEN} = 25\Omega$		
t _f	Fall time	-	5.0	8.0		GEIN			
V	Diode forward voltage	TO-92	-	1.2	1.8	V	V _{GS} = 0V, I _{SD} = 1.0A		
V _{SD}	drop	TO-243AA	-	-	2.0	V	$V_{GS} = 0V, I_{SD} = 0.5A$		
t _{rr}	Reverse recovery time	Reverse recovery time					V _{GS} = 0V, I _{SD} = 1.0A		

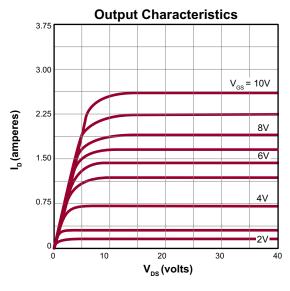
Notes:

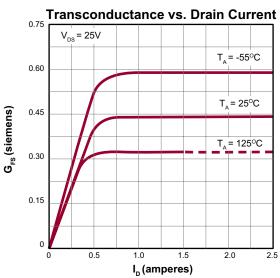
- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

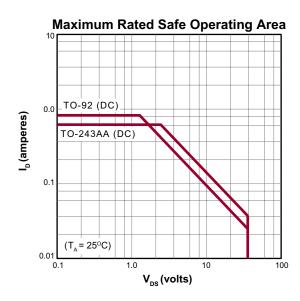
Switching Waveforms and Test Circuit

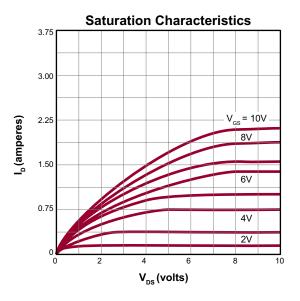


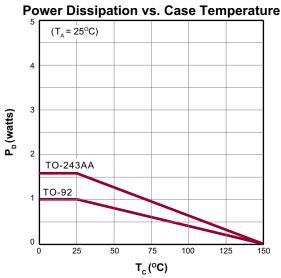
Typical Performance Curves

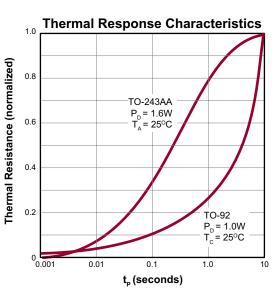




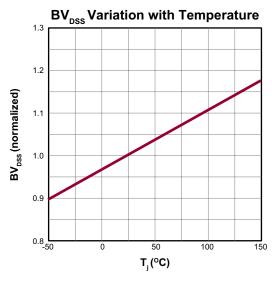


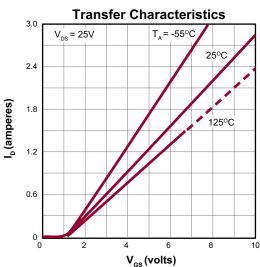


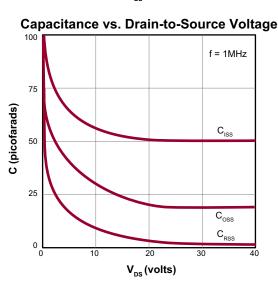


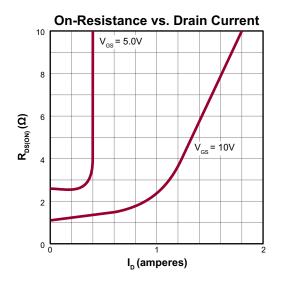


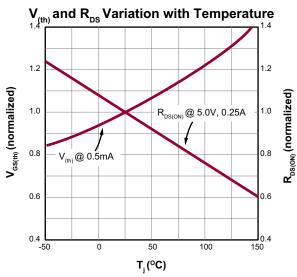
Typical Performance Curves (cont.)

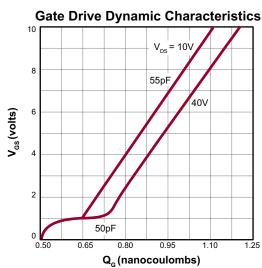




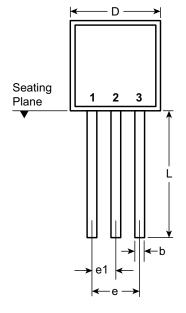


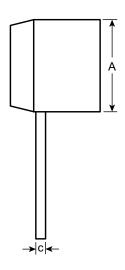






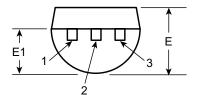
3-Lead TO-92 Package Outline (N3)





Front View

Side View



Bottom View

Symbol		Α	b	С	D	Е	E1	е	e1	L
	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
Dimensions (inches)	NOM	-	-	-	-	-	-	-	-	-
()	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

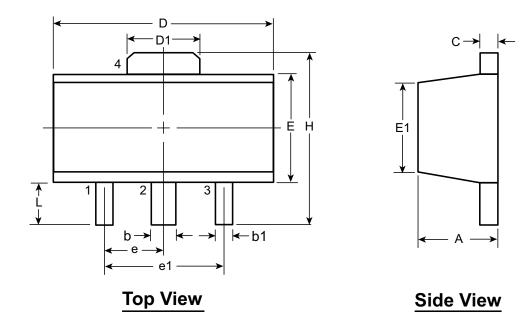
Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

^{*} This dimension is not specified in the JEDEC drawing.

[†] This dimension differs from the JEDEC drawing.

3-Lead TO-243AA (SOT-89) Package Outline (N8)



Symbo	ol	Α	b	b1	С	D	D1	E	E1	е	e1	Н	L
	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00 [†]			3.94	0.73 [†]
Dimensions (mm)	NOM	-	-	-	-	-	-	-	-	1.50 3.00 BSC BSC	3.00 BSC	-	-
(111111)	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29		200	4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

† This dimension differs from the JEDEC drawing

Drawings not to scale.

Supertex Doc. #: DSPD-3TO243AAN8, Version F111010.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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